



MPW schedule

Last updated: September 8, 2023

| MPW name | Fab | Processes | Tape-In | Ship Date |
|--------------------------|---------------|---|----------------------|-----------|
| SB*18 - B5305 | NPB - Fab 3 | SiGe BiCMOS 0.18um (fast track) | 04-04-23 | 10-10-23 |
| CA18 - B5307 | NPB - Fab 3 | RFCMOS 0.18um (fast track) | 05-16-23 | 10-27-23 |
| PH18M* - B5308 | NPB - Fab 3 | SiPho 0.18um | 05-30-23 | 10-13-23 |
| SB*18- B5311 | NPB - Fab 3 | SiGe BiCMOS 0.18um (fast track) | 07-11-23 | 01-18-24 |
| SB*18 - B5314 | NPB - Fab 3 | SiGe BiCMOS 0.18um (fast track) | 09-05-23 | 03-14-24 |
| PH18DA - B5315 | NPB - Fab 3 | SiPho 0.18um | 09-19-23 | 03-22-24 |
| 26th MPW - Uozu, Japan | TPSCo - Fab 7 | CMOS,PM & RFCMOS, 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF | 09-25-23 | |
| SB*/CA/13* - B5316 | NPB - Fab 3 | SiGe BiCMOS / RF CMOS 0.13um (fast track) | 10-03-23 | 05-31-24 |
| CS18* - B5313 | MH - Fab 2 | CMOS-SOI 0.18um | 10-10-23 | |
| 27th MPW - Uozu, Japan | TPSCo - Fab 7 | RFSOI, 65nm : TPS90RSB2, TPS65RSA2/RSB/RSB2 | 10-16-23 | |
| CA18 - B5317 | NPB - Fab 3 | RFCMOS 0.18um (fast track) | 10-17-23 | 03-29-24 |
| PH18M* - B5318 | NPB - Fab 3 | SiPho 0.18um | 10-31-23 | 03-15-24 |
| SB*18 - B5319 | NPB - Fab 3 | SiGe BiCMOS 0.18um (fast track) | 11-14-23 | 05-24-24 |
| SH423T18NOV | MH - Fab 2 | CIS 0.18um Image Sensor CMOS+ 0.16um, 0.18um RF, RFID, PM | 11-14-23 11-21-23 | |
| 27th MPW - Tonami, Japan | TPSCo - Fab 5 | TS18 : CMOS 0.18u & 0.16u, PM, PM_SOI | 11-27-23 | |

(fast track) = Please contact your sales representative for information on fast track processing.

Notes: "Shuttles" (SH*) are run at Fab 2

* 0.13u MH – fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 - Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 - Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 - Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 - Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan